





#### **40V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C		
40V	34mΩ @ V <sub>GS</sub> = 10V	7.2A		
40 V	59mΩ @ V <sub>GS</sub> = 4.5V	5.5A		

### **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- Backlighting
- DC-DC Converters
- Power management functions

#### **Features and Benefits**

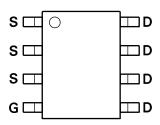
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

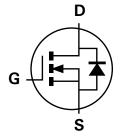
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame.
   Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)







Top View



**Equivalent Circuit** 

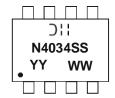
### Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMN4034SSS-13	N4034SS	13	12	2,500	

1. Diodes, Inc. defines "Green" products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

### **Marking Information**

Note:



DII = Manufacturer's Marking N4034SS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01-53)





### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

	Characteristic		Symbol	Value	Unit	
Drain-Source voltage Gate-Source voltage (Note 2)			V <sub>DSS</sub>	40	V	
			V <sub>GS</sub>	±20	V	
		(Note 4)		7.2		
Continuous Drain current	$V_{GS} = 10V$	$T_A = 70^{\circ}C$ (Note 4)	I <sub>D</sub>	5.8	Α	
		(Note 3)		5.4		
Pulsed Drain current V <sub>GS</sub> = 10V		(Note 5)	I <sub>DM</sub>	33.0	А	
Continuous Source current (Body diode)		(Note 4)	I <sub>S</sub>	4.1	Α	
Pulsed Source current (Body diode)		(Note 5)	I <sub>SM</sub>	33.0	А	

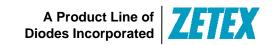
### Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Power dissipation	(Note 3)	D.	1.56 12.5	W
Linear derating factor	(Note 4)	P <sub>D</sub>	2.8 22.5	mW/°C
Thermal Resistance, Junction to Ambient	(Note 3)	0	80	
Thermal Resistance, Junction to Ambient	(Note 4)	$R_{\theta JA}$	44.5	°C/W
Thermal Resistance, Junction to Lead	(Note 6)	$R_{ hetaJL}$	37	
Operating and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

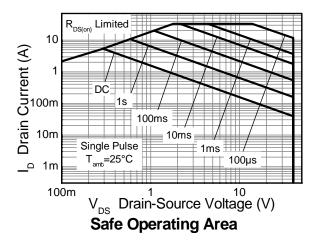
#### Notes:

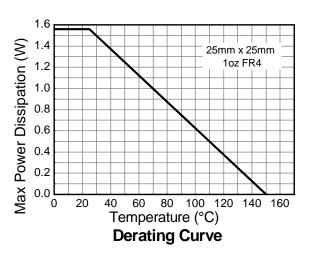
- 2. AEC-Q101  $V_{GS}$  maximum is  $\pm 16V$ .
- 3. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 4. Same as note (3), except the device is measured at t ≤ 10 sec.
  5. Same as note (3), except the device is pulsed with D= 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
  6. Thermal resistance from junction to solder-point (at the end of the drain lead).

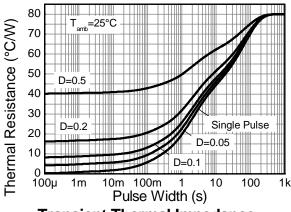


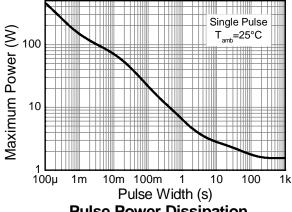


### **Thermal Characteristics**









**Transient Thermal Impedance** 

**Pulse Power Dissipation** 





## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

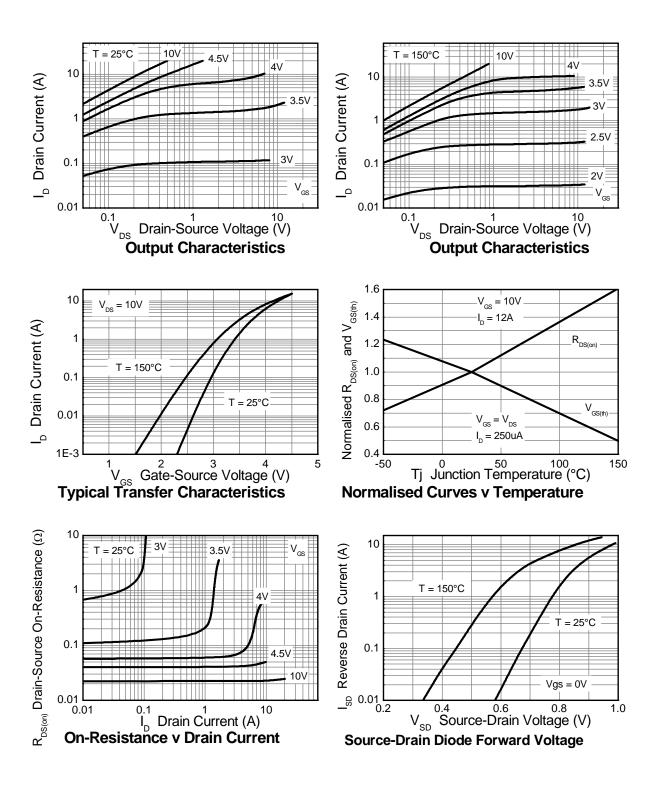
Characteristic	Symbol	Min	Тур	Max	Unit	Test Co	ondition		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40			V	$I_D = 250 \mu A, V_{GS} = 0 V$			
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	0.5	μΑ	$V_{DS}$ = 40V, $V_{GS}$ =	0V		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =	= 0V		
ON CHARACTERISTICS	0 000								
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0		3.0	V	$I_{D}$ = 250 $\mu$ A, $V_{DS}$ =	$V_{GS}$		
Chatia Dunia Cauran On Bonistan an (Note 7)			0.023	0.034	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 6/	A		
Static Drain-Source On-Resistance (Note 7)	R <sub>DS</sub> (ON)	_	0.039	0.059	77	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5			
Forward Transconductance (Notes 7 & 8)	g <sub>fs</sub>	_	20.5	_	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 6/	A		
Diode Forward Voltage (Note 7)	$V_{SD}$	_	0.87	1.1	V	I <sub>S</sub> = 6A, V <sub>GS</sub> = 0V			
Reverse recovery time (Note 8)	t <sub>rr</sub>		11.9	_	ns	I <sub>S</sub> = 2.5A, di/dt= 100A/μs			
Reverse recovery charge (Note 8)	$Q_{rr}$	_	4.9	_	nC	$I_S = 2.5A$ , $di/dt = 1$	υυΑ/μς		
DYNAMIC CHARACTERISTICS (Note 8)	, , ,								
Input Capacitance	C <sub>iss</sub>	_	453	_	pF	.,			
Output Capacitance	Coss	_	79.1	_	pF	V <sub>DS</sub> = 20V, V <sub>GS</sub> = f= 1MHz	UV		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	40.5		рF	I - TIVII IZ			
Total Gate Charge (Note 9)	Qg	_	4.9		nC	V <sub>GS</sub> = 4.5V			
Total Gate Charge (Note 9)	$Q_g$	_	10	_	nC		V <sub>DS</sub> = 20V		
Gate-Source Charge (Note 9)	Q <sub>gs</sub>	_	1.8	_	nC	V <sub>GS</sub> = 10V	$I_D = 6A$		
Gate-Drain Charge (Note 9)	Q <sub>gd</sub>	_	2.4	_	nC	1			
Turn-On Delay Time (Note 9)	t <sub>D(on)</sub>	_	2.7	_	ns				
Turn-On Rise Time (Note 9)	t <sub>r</sub>	_	2.7	_	ns	V <sub>DD</sub> = 20V, V <sub>GS</sub> = 10V			
Turn-Off Delay Time (Note 9)	t <sub>D(off)</sub>	_	14	_	ns	$I_{D}=1A, R_{G}\cong 6.0\Omega$			
Turn-Off Fall Time (Note 9)	t <sub>f</sub>	_	6		ns				

Notes:

- 7. Measured under pulsed conditions. Pulse width  $\le 300 \mu s$ ; duty cycle  $\le 2\%$  8. For design aid only, not subject to production testing. 9. Switching characteristics are independent of operating junction temperatures.

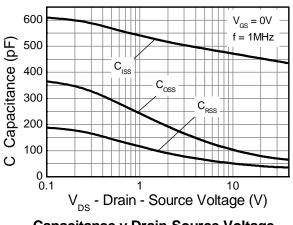


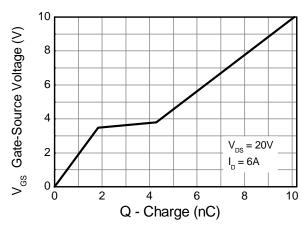
# **Typical Characteristics**





### Typical Characteristics - continued

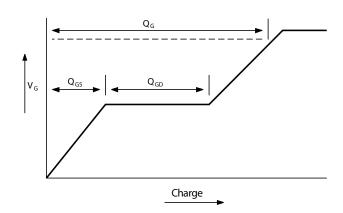




Capacitance v Drain-Source Voltage

**Gate-Source Voltage v Gate Charge** 

### **Test Circuits**



Current regulator

12V 0.2µF 50k D.U.T

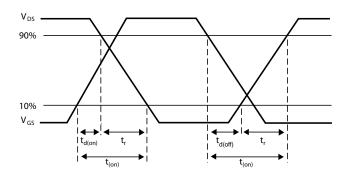
V<sub>os</sub>

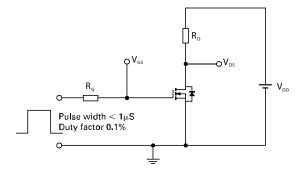
D.U.T

V<sub>os</sub>

Basic gate charge waveform

Gate charge test circuit



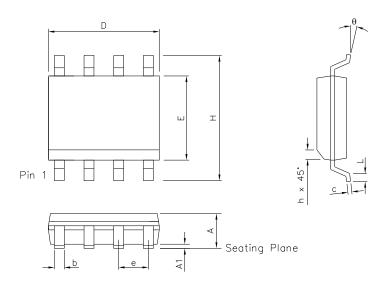


Switching time waveforms

Switching time test circuit

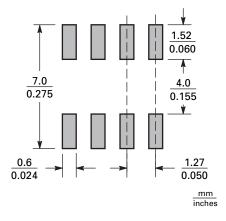


# **Package Outline Dimensions**



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
Α	0.053	0.069	1.35	1.75	е	0.050 BSC		1.27 BSC	
A1	0.004	0.010	0.10	0.25	b	0.013	0.020	0.33	0.51
D	0.189	0.197	4.80	5.00	С	0.008	0.010	0.19	0.25
Н	0.228	0.244	5.80	6.20	θ	0°	8°	0°	8°
Е	0.150	0.157	3.80	4.00	h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27	-	-	-		-

# **Suggested Pad Layout**







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